



Global Maintenance & Equipment Lead Engineer Thinning, Glass Bonding & Spin Etch (f/m/div)*)

Job description

Are you passionate about innovative equipment productivity improvement? Are you looking for a new challenge within the semiconductor industry? At Infineon you will develop a living quality culture at all levels and be part of the success of our company. Apply now and join our team as a Global Lead Engineer (f/m/div)* at the Thinning, Glass Bonding & Spin Etch department. It is possible to work at one of the sites at Villach, Dresden, Regensburg or Kulim.

In your new role you will:

- have to **align all team-members** other BPI teams
- balance peer group interests for **specific implementation topics**
- prioritize **work packages and actions** to fulfill expected targets (performance quality costs)
- **transfer best known method** to all sites (implementation & driving continuous improvement)
- lead **projects as well as sub-projects** (technical)
- implement **sustainable measures** to reduce excursions and customer returns
- **expand measures, best known methods & new innovations** to all sites
- develop **new advanced methods** to improve productivity

Profile

You are best equipped for this task if you have:

- a **degree** from university or university of applied science in **mechanics, electronics, pneumatics, chemistry, physics, mathematics** or a **higher technical degree** (for example Higher Institute of Technical Education (HTL) with comparable educational background
- **assertiveness** as well as **strong leadership skills** and **independent working method**
- a fundamental knowledge of the **semiconductor processes** in relevant area
- strong expertise in the specific area
- know-how of **standard QCC tools** (Fish bone, 8D, CDPA)
- basic knowledge of **project management**

At a glance

Location:
Job ID: **338773**
Start date: **as soon as possible**
Entry level: **5+ years**
Type: **Full time**
Contract: **Permanent**

Apply to this position online by following the URL and entering the Job ID in our job search:

Job ID: **338773**
www.infineon.com/jobs

Contact

Andrea Wolfinger
Talent Attraction Manager



- **good English** language skills, German as a plus

We offer competitive salaries and additional benefits based on your performance, experience and qualification. The employment is in accordance with the collective salary and wage agreement for employees of the electrical and electronics industry, employment group H (<https://www.feei.at/wp-content/uploads/2021/04/minimum-salaries-white-collar-workers-2021.pdf>). The monthly salary is paid 14 times p.a. We offer a higher compensation depending on your expertise and skills.

Why Us

Part of your life. Part of tomorrow.

We make life easier, safer and greener – with technology that achieves more, consumes less and is accessible to everyone. Microelectronics from Infineon is the key to a better future. Efficient use of energy, environmentally-friendly mobility and security in a connected world – we solve some of the most critical challenges that our society faces while taking a conscientious approach to the use of natural resources.

The **Frontend (FE) cluster** offers a broad range of manufacturing competence specialized in high-quality logic products. The portfolio represents Power, Bipolar, Sensor, Passive and Diode technologies as well as CMOS, RF-CMOS and embedded flash technologies. The manufacturing sites in Dresden, Kulim, Regensburg and Villach are committed to Operational Excellence with strong customer focus.

** The term gender in the sense of the General Equal Treatment Act (GETA) or other national legislation refers to the biological assignment to a gender group. At Infineon we are proud to embrace (gender) diversity, including female, male and diverse.*

